

ESDZV5-1BF4

Datasheet



Features

- Ultra low clamping voltage: 7 V (IEC 61000-4-2 contact discharge 8 kV at 30 ns / 16 A TLP)
- Bidirectional device
- Low leakage current
- 0201 package
- ECOPACK2 compliant component
- Exceeds the followig standard:
 - IEC 61000-4-2 level 4 = \pm 30 kV (air discharge) and \pm 18 kV (contact discharge)

Application

Where transient over voltage protection in ESD sensitive equipment is required, such as:

- Smartphones, mobile phones and accessories
- Tablets and notebooks
- Portable multimedia devices and accessories
- Wearable, home automation, healthcare
- Highly integrated systems

Description

The ESDZV5-1BF4 is a bidirectional single line TVS diode designed to protect the data line or other I/O ports against ESD transients.

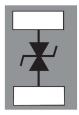
The device is ideal for applications where both reduced line capacitance and board space saving are required.





0201 package

Figure 1. Functional diagram





1 Characteristics

Table 1. Absolute ratings (T _{amb} = 25 °C)	Table 1	Absolute	ratings	(T _{amb} =	25 °C)
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Symbol	Parameter	Value	Unit	
V _{PP}	Peak pulse voltage	Contact discharge	18	kV
•pp	reak puise voltage	Air discharge	30	ΓV
P _{PP}	Peak pulse power dissipation (8/20 µs)	70	W	
I _{PP}	Peak pulse current (8/20 µs)	7	Α	
Tj	Operating junction temperature range	-55 to +150	°C	
T _{stg}	Storage temperature range	-65 to +150	°C	
TL	Maximum lead temperature for soldering during 10 s	260	°C	

Figure 2. Electrical characteristics (definitions)

Symbol		Parameter
V_{Trig}	=	Trigger voltage
V _{CL}	=	Clamping voltage
I _{RM}	=	Leakage current @V _{RM}
V_{RM}	=	- Stand-off voltage
I _{PP}	=	Peak pulse current
R_{D}	=	Dynamic resistance
V _H	=	Holding voltage
C_{LINE}	=	Input capacitance per line

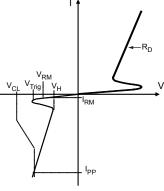


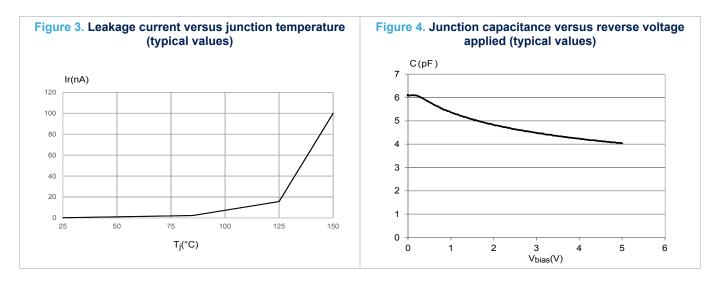
Table 2. Electrical characteristics (T_{amb} = 25 °C)

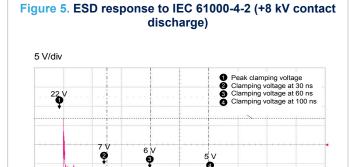
Symbol	Test condition	Min.	Тур.	Max.	Unit
V _{Trig}	Higher voltage than V_{Trig} guarantees the protection turn-on	5.8		10	V
V _H	Lower voltage than V_H guarantees the protection turn-off	4	4.6		
I _{RM}	V _{RM} = 5.5 V ⁽¹⁾			100	nA
V _{CL}	8 kV contact discharge after 30 ns, IEC 61000-4-2		7		V
V _{CL}	8/20 μs waveform, I _{PP} = 7 A			10	V
C _{LINE}	$F = 1 \text{ MHz}, V_{\text{LINE}} = 0 \text{ V}, V_{\text{OSC}} = 30 \text{ mV}$		6	7.5	pF
R _D	Pulse duration 100 ns		0.18		Ω

1. Application note: when used to protect a line connected to a DC source, the DC voltage must be lower than the minimum V_H to enable the diode to return to its non-conducting state after the transient.



Characteristics (curves) 1.1



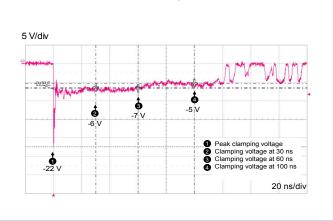


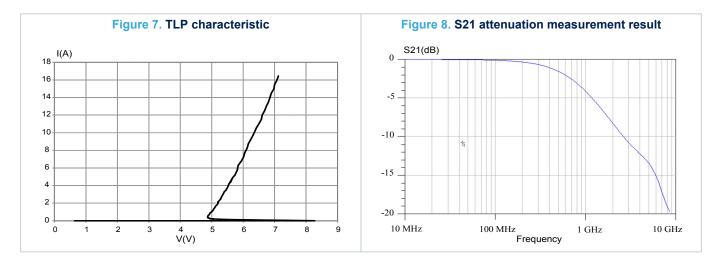
5 V ø

=:=:=|=:=:=:=:=:=:=:

20 ns/div







=:=:=:

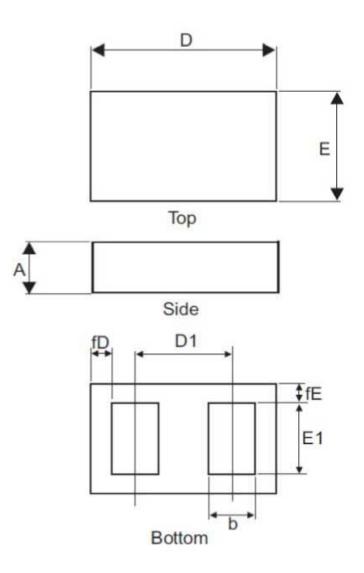
57

2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 0201 package information





Note:

The marking codes can be rotated by 90 ° or 180° to differentiate assembly location. In no case should this product marking be used to orient the component for its placement on a PCB. Only pin 1 mark is to be used for this purpose.

Table 3. 0201 package mechanical data

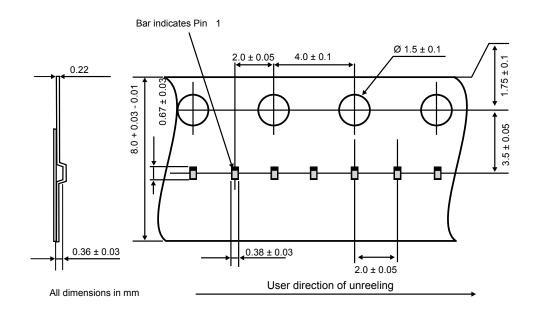
		Dimensions			
Ref.	Millimeters				
	Min.	Тур.	Max.		
A	0.270	0.300	0.330		
b	0.1675	0.1875	0.2075		
D	0.560	0.580	0.600		
D1		0.3375			
E	0.260	0.280	0.300		
E1	0.205	0.225	0.245		
fD	0.0175	0.0275	0.0375		
fE	0.0175	0.0275	0.0375		

Figure 10. Marking



Note: The marking can be rotated by multiples of 90° to differentiate assembly location.

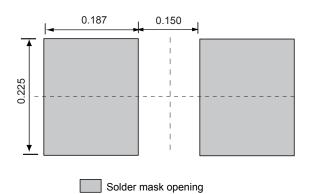
Figure 11. Tape and reel specification (in mm)



3 Recommendation on PCB assembly

3.1 Footprint

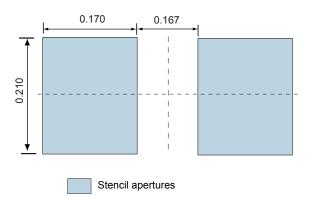
Figure 12. Recommended footprint in mm



3.2 Stencil opening design

- 1. Reference design
 - a. Stencil opening thickness: 75 µm / 3 mils

Figure 13. Recommended stencil window position in mm



3.3 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Use solder paste with fine particles: powder particle size 20-38 μm.

3.4 Placement

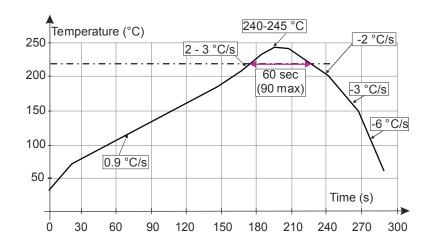
- 1. Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering
- 3. Standard tolerance of ±0.05 mm is recommended.
- 4. 1.0 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 5. To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- 6. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

3.5 PCB design preference

- 1. To control the solder paste amount, the closed via is recommended instead of open vias.
- 2. The position of tracks and open vias in the solder area should be well balanced. A symmetrical layout is recommended, to avoid any tilt phenomena caused by asymmetrical solder paste due to solder flow away.

3.6 Reflow profile

Figure 14. ST ECOPACK recommended soldering reflow profile for PCB mounting



Note:

Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.



4 Ordering information

ESD Ζ V 5 F4 - 1 В ESD protection Z : Ultra low Clamping snapback effect V : Very Low Capacitance 5 : Standoff voltage at 5.5 V max. Number of lines B = Bi-directional Package F4 = 0201

Figure 15. Ordering information scheme

Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
ESDZV5-1BF4	A ⁽¹⁾	0201	0.116 mg	15000	Tape and reel

1. The marking can be rotated by multiples of 90° to differentiate assembly location

Revision history

Table 5. Document revision history

Date	Revision	Changes
06-Apr-2017	1	First issue.
28-Jul-2017	2	Updated footprint title.
19-Jan-2022	3	Updated Figure 12. Minor text changes.

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